

# MOS INTEGRATED CIRCUIT $\mu PD4701A$

## INCREMENTAL ENCODER COUNTER

#### **DESCRIPTION**

The  $\mu$ PD4701A is a counter for an X, Y 2-axis incremental encoder. When a two-phase encoder signal is input for the X and Y axes, direction discrimination and computation is performed, and count data is output in 8-bit parallel form. In addition, a 3-contact-point input buffer is incorporated, which is useful for applications which use a pointing device such as a mouse or track-ball. The CPU checks the switch input flag or count flag and reads the 12-bit count data in two operations, one for the lower byte and one for the upper byte. The key input flag is output together with the count data in the upper byte.

#### **FEATURES**

- X, Y 2-axis incremental encoder counter
- · Counter input (Schmitt-triggered input)

 $\left.\begin{array}{lll} X \ axis: & X_A, \ X_B \ 2\text{-phase signal} \\ Y \ axis: & Y_A, \ Y_B \ 2\text{-phase signal} \end{array}\right\} 4\text{-multiplication count method used}$ 

Counters: 12-bit binary up/down counters (2 sets, X & Y)

Reset value: 000H

- Count data output: 8-bit parallel latch output × 2 (including key input flag)
- · On-chip 3-contact-point key input buffer circuit
- CMOS
- Single +5 V power supply

#### PIN NAMES

 $\begin{array}{c} X_A, \ Y_A \ : \ A\text{-phase inputs} \\ \hline X_B, \ Y_B \ : \ B\text{-phase inputs} \\ \hline \hline RIGHT \\ \hline LEFT \\ \hline MIDDLE \\ \hline \hline CS \ : \ Chip \ Select \\ \hline \hline X/Y \ : \ X/Y \ Counter \ Select \\ \hline U/L \ : \ Upper/Lower \ Byte \ Select \\ \hline D_0 \ to \ 7 \ : \ Data \ outputs \\ \hline \hline \end{array}$ 

CF : Count flag RESET X Counter
SF : Count flag RESET Y reset inputs

#### 23 Хв ○— **-**○ D<sub>7</sub> RESET X O-22 **-**○ D<sub>6</sub> 21 -○ D<sub>5</sub> Үв ⊙---20 --○ D4 RESET Y O-19 -○ D<sub>3</sub> RIGHT O-18 --○ D2 LEFT 0-8 17 -○ D<sub>1</sub> MIDDLE O-9 16 -O D₀

SF ○<del>-</del>

CF ○<del></del>

Vss O-

10

11

PIN CONFIGURATION (Top View)

24

15

14

13

-⊙ Vdd

 $\overline{\sim} \overline{\mathsf{cs}}$ 

--○ X/Y

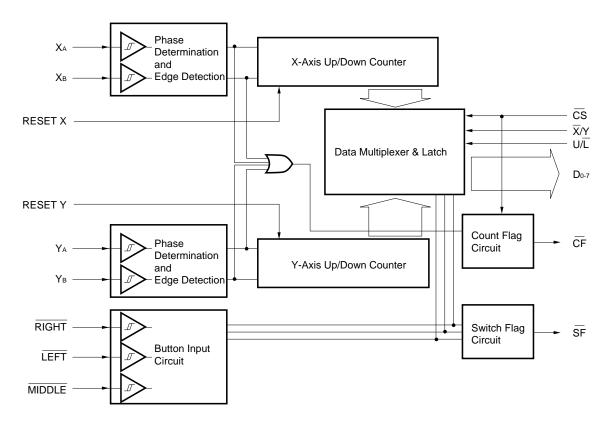
⊸ U/L



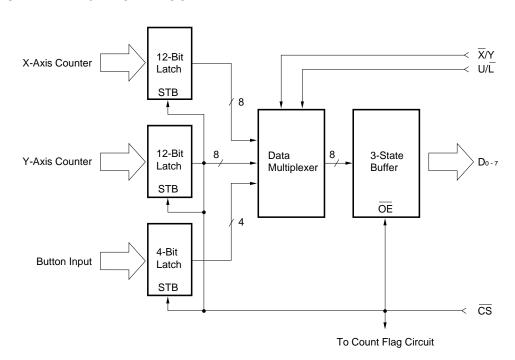
## ORDERING INFORMATION

Part Number	Package
μPD4701AC	24-pin plastic DIP (600 mil)
μPD4701AGT	24-pin plastic SOP (375 mil)

## **BLOCK DIAGRAM**



## DATA MULTIPLEXER/LATCH BLOCK





## PIN FUNCTIONS

	Pin Name	Input/Output	Function		
CPU interface block	ĊŚ	Input	Chip Select input. "L" input activates outputs D0 to 7. "H" input sets outputs D0 to 7 to high impedance. Output data is latched on the fall edge of $\overline{CS}$ . "L" must be maintained during a count data read.		
	X/Y	Input	Counter Select input. "L" input selects the X counter, and "H" input selects the Y counter.		
	U/L	Input	Byte Select input. "L" input selects the lower byte and "H" input selects the upper byte, controlling data output.		
	RESET X RESET Y	Input	Counter reset inputs. RESET X input resets the X counter, and RESET Y input resets the Y counter. Both are active-"H".		
	D <sub>0</sub> to 7	Output (3-state)	Bus for data output to the CPU. Outputs the byte data selected by the $\overline{X}/Y$ and $U/\overline{L}$ inputs.  The data latched on the fall of $\overline{CS}$ is output.		
	CF	Output	Counter flag output. Set (= "L" output) when the X or Y counter changes while $\overline{CS}$ = "H". Reset (= "H" output) on the fall of $\overline{CS}$ . While $\overline{CS}$ = "L", count flag output is disabled and the "H" level is output.		
	SF	Output	Switch flag output. Becomes active (= "L" output) when the RIGHT, LEFT or MIDDLE switch input is "L".		
Mouse interface	Ха, Хв	Input (Schmitt input)	X counter 2-phase signal input pins		
block	Ya, Yb	Input (Schmitt input)	Y counter 2-phase signal input pins		
	RIGHT LEFT MIDDLE	Input (Schmitt input)	Key switch input pins. Key switch input are read as the high-order 4 bits of the X counter and Y counter upper byte as the internal status.  Upper Byte  SF L R M C <sub>11</sub> C <sub>10</sub> C <sub>9</sub> C <sub>8</sub> Key Input Status Count Data		
Power	V <sub>DD</sub>		+5 V power supply connection pin		
supply block	Vss		Ground pin		



#### **DESCRIPTION OF OPERATIONS**

#### 1. COUNT OPERATION

The  $\mu$ PD4701A executes an up-count and down-count by means of A & B 2-phase signals in the 12-bit up-down counter. An up-count is performed when the A-phase signals (X<sub>A</sub>, Y<sub>A</sub>) are phase-advanced, and a down-count is performed when the B-phase signals (X<sub>B</sub>, Y<sub>B</sub>) are phase-advanced. The edge of each signal is a count source. (4-multiplication count method: see Fig. 1.)

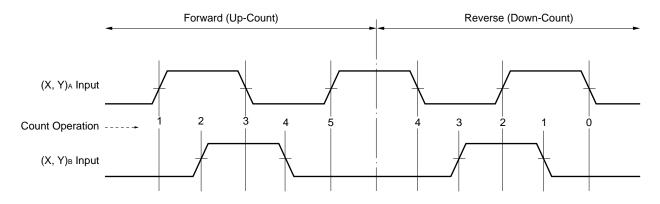


Fig. 1 Count Operation Timing Chart

This count operation is executed independently for the X axis (XA, XB) and Y axis (YA, YB). This operation is initialized by reset input (RESET X, RESET Y) only.

In an up-count, the next value after FFFH is 000H, and in a down-count, the next value after 000H is FFFH.

## 2. OPERATION OF COUNT FLAG, CF

The count flag,  $\overline{CF}$ , indicates that a count source (either  $X_{A,\,B}$  or  $Y_{A,\,B}$  edge input) has occurred while the  $\overline{CS}$  signal is "H", and is an active-low output.  $\overline{CF}$  is reset ( $\rightarrow$  "H") by  $\overline{CS}$  signal "L" input. While  $\overline{CS}$  = "L", count flag output is disabled and the "H" level is output.

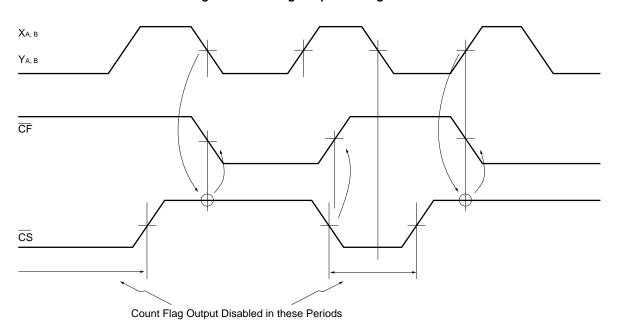
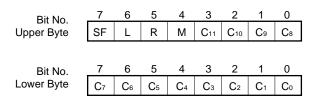


Fig. 2 Count Flag Output Timing Chart

#### 3. SWITCH INPUT OPERATION

The  $\mu$ PD4701A can process up to 3 contact points as switch inputs (active-"L" input). Switch input is read as part of the count data upper byte together with the switch flag status as an internal status (see Fig. 3). These are all active-"H" outputs. The switch flag status, SF, is equivalent to the switch flag output,  $\overline{SF}$ , described below.

Fig. 3 Data Output Format



SF: Switch Flag
L: Left Switch
R: Right Switch
M: Middle Switch
C11-0: Count Data (12 bit )

## 4. OPERATION OF SWITCH FLAG, SF

The switch flag,  $\overline{SF}$ , becomes active (active-"L" output) when the  $\overline{RIGHT}$ ,  $\overline{LEFT}$  or  $\overline{MIDDLE}$  switch input is "L".  $\overline{SF}$  can also be read as the switch flag status together with the count data.

#### 5. DATA READ OPERATION

The CPU reads the count data and switch input status by controlling  $\overline{CS}$ ,  $\overline{X}/Y$  and  $U/\overline{L}$ . The relation between these is shown in Table 1. (At this time, the data latched on the falling edge of  $\overline{CS}$  is output. If  $\overline{X}/Y$  or  $U/\overline{L}$  is switched while  $\overline{CS}$  is still "L", the data at the point at which  $\overline{CS}$  changes from "H" to "L" is read. When  $\overline{CS}$  is set to "H", new data is read into the latch, and the new data is confirmed on the next fall of CS.

**Table 1 Data Output Table** 

cs	X/Y	U/L	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	Dз	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
0	0	0	хС7	хС6	хС5	хС4	хСз	xC2	хС1	хСо
0	0	1	SF	L	R	М	xC11	xC10	хС9	хС8
0	1	0	<b>УС</b> 7	<b>УС</b> 6	Y <b>C</b> 5	YC4	<b>УС</b> 3	YC2	YC1	YC0
0	1	1	SF	L	R	М	YC11	YC10	YC9	YC8
1	×	×	FLOATING							



## 6. CONNECTION TO CPU SYSTEM

An example of connection to a CPU system is shown in Fig. 4.

RESET Mouse **Output Port** A<sub>2</sub> - A<sub>n</sub> and IORD or MRD  $\mathbf{X}_{\mathsf{A}}$  $\bar{\mathsf{cs}}$  $\chi_{\text{B}}$ X/Y  $A_1$  $\mathsf{U}/\overline{\mathsf{L}}$ Αo  $Y_A$  $Y_{\mathsf{B}}$ DB<sub>0</sub> - 7 **D**0 - 7 CPU System  $\mu$ PD4701A RIGHT SF FLAG  $\overline{\mathsf{INT}}$ **MIDDLE** CF LEFT Mouse I/F

Fig. 4 Example of Connection to CPU System

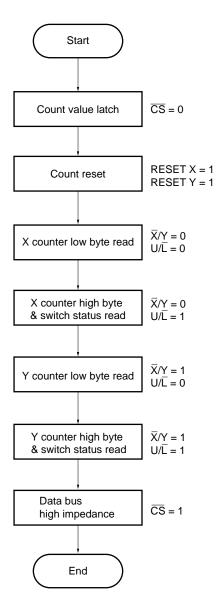
μPD4701A Pin Name	Description
X/Y	Connected to address line A <sub>1</sub> .
U/L	Connected to address line A <sub>0</sub> .
<u>cs</u>	Connects address lines A <sub>2</sub> to A <sub>n</sub> and the signal resulting from decoding $\overline{\text{IORD}}$ in the I/O address mode or $\overline{\text{MRD}}$ in the memory address mode, or an output port. The low level must be maintained during a count data read.
D <sub>0</sub> to 7	Connected to the data bus.
SF, CF	When these are used as interrupt signals, they are connected to the CPU INT pin.
RESET X \	These are connected to a CPU output port or reset signal.
RESET Y ∫	

The above connections enable the CPU to read the X counter, Y counter and switch input status.

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

An example of a  $\mu$ PD4701A data read is shown in Fig. 5.

Fig. 5 Example of  $\mu$ PD4701A Data Read



\*  $\overline{\text{CS}}$  must be kept at "0" during the read.



#### 7. APPLICATION AREAS

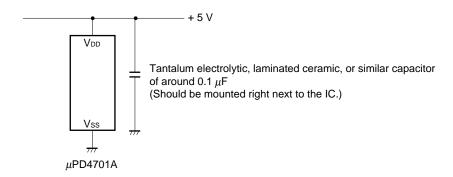
Two-phase incremental signals are used for detection and measurement of a vector quantity (a quantity that has direction and magnitude), and are widely employed in measuring instruments such as micrometers and linear scales, control systems for digital servo motors, X-Y tables, etc., head position control for printers, magnetic disks, etc., robot arm position control, and so on.

The  $\mu$ PD4701A incorporates the direction judgment circuit and count pulse generator required for 2-phase incremental signal processing, up/down counters for counting these pulses, and a data latch to hold the read data, in IC form, enabling an X, Y 2-axis incremental signal processing system to be implemented easily.

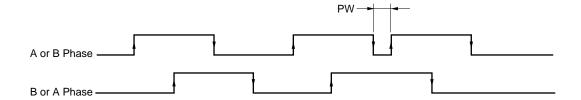
In addition, a 3 switch-input buffer is incorporated, enabling this device to be widely used in man-machine interface and centronics interface application areas.

#### 8. OPERATING PRECAUTIONS

1) As the  $\mu$ PD4701A incorporates two sets of 12-bit counters, large transient currents flow during a count operation. Adecoupling capacitor of around 0.1  $\mu$ F should therefore be inserted between V<sub>DD</sub> and Vss of the  $\mu$ PD4701A.



2) If a pulse shorter than the signal phase difference time tsab (350 ns) is input to the A/B phase inputs (XA, XB, YA, YB) this will result in a miscount. Therefore, if pulses shorter than tsab are to be input because of encoder bounds, etc., a filter should be attached to the A/B phase inputs.



If PW  $\geq$  tsAB (350 ns), the count value remains the same before and after pulse input. (UP count  $\rightarrow$  DOWN count or DOWN count  $\rightarrow$  UP count is implemented, and therefore the result is equivalent to no change in the count value.



# ABSOLUTE MAXIMUM RATINGS ( $T_a = 25$ °C, $V_{SS} = 0$ V)

PARAMETER	SYMBOL	RATING	UNIT
Supply voltage	V <sub>DD</sub>	-0.5 to +7.0	V
Input voltage	Vı	-1.0 to V <sub>DD</sub> + 1.0	V
Output voltage	Vo	−0.5 to V <sub>DD</sub> + 0.5	V
Operating temperature	Topt	-40 to +85	°C
Storage temperature	T <sub>stg</sub>	-65 to +150	°C
Permissible loss	PD	500	mW

# DC CHARACTERISTICS (Ta = -40 to +85 °C, V<sub>DD</sub> = +5 V $\pm$ 10 %)

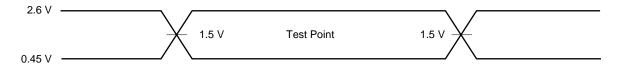
PARAMETER	SYMBOL	RATING		UNIT	TEST CONDITIONS	
FARAWLILK	STWIBOL	MIN.	MAX.	ONIT	TEST CONDITIONS	
Input voltage high	VIL		0.8	V		
Input voltage low	Vін	2.6		V	X <sub>A</sub> , X <sub>B</sub> , Y <sub>A</sub> , Y <sub>B</sub> and LEFT, RIGHT, MIDDLE	
	ViH	2.2		V	Other than the above	
Output voltage low	Vol		0.45	V	IoL = 12 mA	
Output voltage high	Vон	V <sub>DD</sub> - 0.8		V	Iон = −4 mA	
Static consumption current	IDD		50	μΑ	VI = VDD, VSS	
Input current	lı	-1.0	1.0	μΑ	VI = VDD, VSS	
3-state output leak current	loff	-10	10	μΑ		
Dynamic consumption current	IDD dyn		2	mA	fin = 500 kHz	
Hysteresis voltage	Vн	0.25		V	X <sub>A</sub> , X <sub>B</sub> , Y <sub>A</sub> , Y <sub>B</sub> and LEFT, RIGHT, MIDDLE	



## AC CHARACTERISTICS (Ta = -40 to +85 °C, Vdd = +5 V $\pm$ 10 %)

PARAMETER		SYMBOL	RA	ΓING	UNIT	TEST CONDITIONS
	FARAIVIETER	STIVIBOL	MIN.	MAX.	UNIT	TEST CONDITIONS
Ха, Хв	Input cycle	<b>t</b> CYAB	2		μs	fin = 500 kHz
Үа, Үв	High-level pulse width	<b>t</b> pwabh	900		ns	
	Low-level pulse width	<b>t</b> PWABL	900		ns	
	Signal phase difference time	<b>t</b> sab	350		ns	
R, L	High-level pulse width	tрwswн	30		μs	Switch OFF
M	Low-level pulse width	<b>t</b> PWSWL	30		μs	Switch ON
SF	Setting delay time	tosfl		50	ns	Switch ON
	Reset delay time	<b>t</b> DSFH		50	ns	Switch OFF
RESET	Pulse width	tpwrs	100		ns	
W, Y	Count enable time	tscten	0		ns	From RESETx, y ↓
	Count clear time	<b>t</b> DCTCL		100	ns	From RESETx, y ↑
CF	Flag setting time	<b>t</b> DABCF		120	ns	From XA, B, YA, B
	Flag reset time	tocscf		100	ns	From <del>CS</del> ↓
	Count setting time	tscт	0		ns	From <del>CF</del> ↓
cs	CF enable time	tscscf	140		ns	From <del>CF</del> ↓
	CF disable time	<b>t</b> HABCS	140		ns	From XA, B, YA, B
	Pulse width	tpwcs	200		ns	
X/Y	Address setup time	tsacs	0		ns	To CS ↓
U/L	Address hold time	<b>t</b> HCSAB	0		ns	From CS ↑
D <sub>0</sub> to 7	Output delay time	tocso		150	ns	From <del>CS</del> ↓
	Output delay time	<b>t</b> dad		100	ns	From X/Y, U/L
	Floating time	trcsd		50	ns	From CS ↑

## AC TEST INPUT WAVEFORM



AC test: The input is driven by 2.6 V for logic "1", and 0.45 V for logic "0".

Timing measurement is performed at 1.5 V for both logic "1" and logic "0".

Fig. 6 Two-Phase Signal & Switch Signal Input Timing

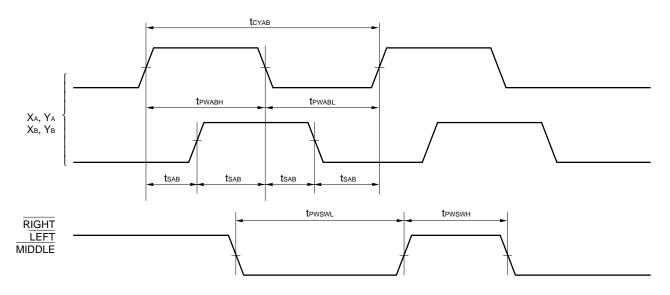


Fig. 7 Count Flag Output Timing

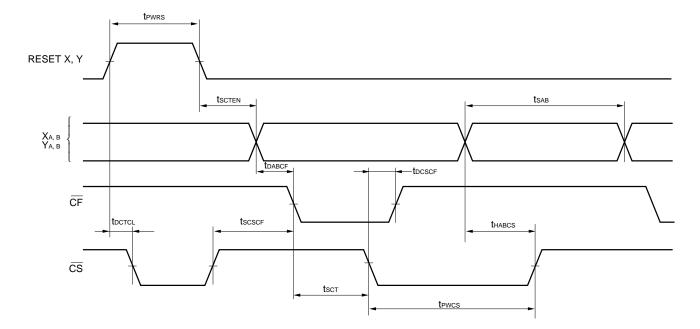




Fig. 8 Data Output Timing

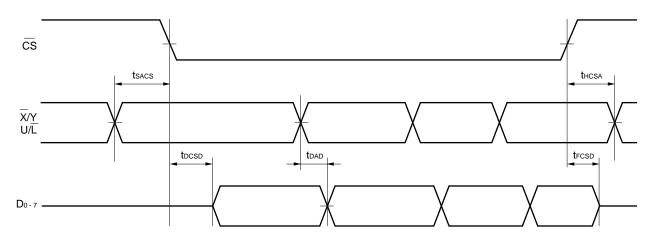
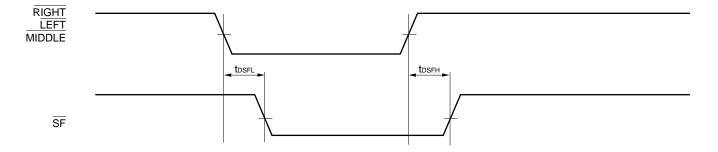


Fig. 9 Switch Flag Signal Output Timing





## RECOMMENDED SOLDERING CONDITIONS

The following conditions (see table below) must be met when soldering this product.

Please consult with our sales offices in case other soldering process is used, or in case soldering is done under different conditions.

## TYPES OF SURFACE MOUNT DEVICE

## $\mu$ PD4701AGT

Soldering process	Soldering conditions	Symbol
Infrared ray reflow	Peak package's surface temperature: 235 °C or below, Reflow time: 30 seconds or below (210 °C or higher), Number of reflow process: 2, Exposure limit*: None	IR35-00-2
VPS	Peak package's surface temperature: 215 °C or below, Reflow time: 40 seconds or below (200 °C or higher), Number of reflow process: 2, Exposure limit*: None	VP15-00-2
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or below, Number of flow process: 1, Exposure limit*: None	WS60-00-1
Partial heating method	Terminal temperature: 300 °C or below, Flow time: 10 seconds or below, Exposure limit*: None	

<sup>\*</sup> Exposure limit before soldering after dry-pack package is opened. Storage conditions: 25 °C and relative humidity at 65 % or less.

Note Do not apply more than a single process at once, except for "Partial heating method".

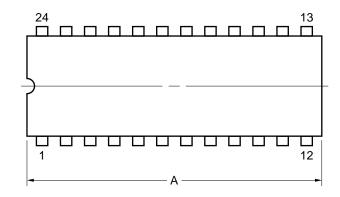
## TYPE OF THROUGH HOLE MOUNT DEVICE

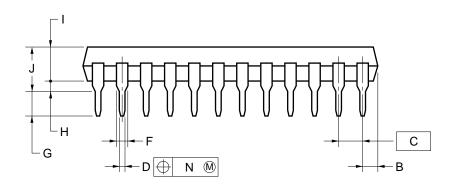
## $\mu$ PD4701AC

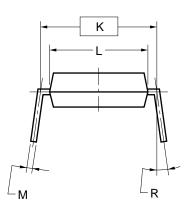
Soldering process	Soldering conditions	Symbol
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or below	



# 24PIN PLASTIC DIP (600 mil)







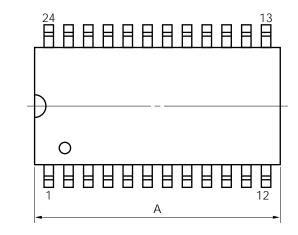
## NOTES

- 1) Each lead centerline is located within 0.25 mm (0.01 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS	INCHES
Α	33.02 MAX.	1.300 MAX.
В	2.54 MAX.	0.100 MAX.
С	2.54 (T.P.)	0.100 (T.P.)
D	0.50±0.10	$0.020^{+0.004}_{-0.005}$
F	1.2 MIN.	0.047 MIN.
G	3.5±0.3	0.138±0.012
Н	0.51 MIN.	0.020 MIN.
I	4.31 MAX.	0.170 MAX.
J	5.72 MAX.	0.226 MAX.
K	15.24 (T.P.)	0.600 (T.P.)
L	13.2	0.520
М	0.25 <sup>+0.10</sup> -0.05	$0.010^{+0.004}_{-0.003}$
N	0.25	0.01
R	0~15°	0~15°

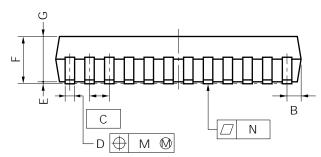
P24C-100-600-1

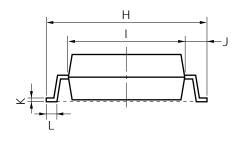
## 24 PIN PLASTIC SOP (375 mil)



detail of lead end







P24GT-50-375B-1

## NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
А	15.71 MAX.	0.619 MAX.
В	0.87 MAX.	0.035 MAX.
С	1.27 (T.P.)	0.050 (T.P.)
D	$0.40^{+0.10}_{-0.05}$	$0.016^{+0.004}_{-0.003}$
Е	0.125±0.075	0.005±0.003
F	2.9 MAX.	0.115 MAX.
G	2.50±0.2	$0.098\substack{+0.009 \\ -0.008}$
Н	10.3±0.3	$0.406\substack{+0.012 \\ -0.013}$
I	7.2±0.2	$0.283\substack{+0.009 \\ -0.008}$
J	1.6±0.2	0.063±0.008
K	$0.15^{+0.10}_{-0.05}$	$0.006\substack{+0.004 \\ -0.002}$
L	0.8±0.2	$0.031^{+0.009}_{-0.008}$
М	0.12	0.005
N	0.10	0.004

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